

## Observation of Sub-bandgap Photodetection at 2 $\mu\text{m}$ wavelengths in a Germanium Lateral PIN Photodetector

<sup>o</sup>Ziqiang Zhao<sup>1</sup>, Chongpei Ho<sup>1</sup>, Qiang Li, Kasidit Toprasertpong<sup>1</sup>, Shinichi Takagi<sup>1</sup> and Mitsuru Takenaka<sup>1</sup> (<sup>1</sup>The University of Tokyo)  
E-mail: zhaozq@mosfet.t.u-tokyo.ac.jp

**Introduction:** Being boosted by the crying needs for high-speed and broad-band data communication, silicon (Si) photonics has attracted people's attention not only in the near-infrared region but also in the mid-infrared (MIR) wavelengths [1]. Moreover, with the evolution of low-loss hollow-core optical fibers and thulium/holmium optical amplifiers, developments of photonic building blocks for MIR have been promoted [2]. Particularly, monolithic Si photodetectors (PDs) operating at sub-bandgap wavelengths, i.e. 2  $\mu\text{m}$ , through defects mediation have been reported [3]. In this work, we reported sub-bandgap photodetection in Germanium (Ge) lateral PIN PDs on Ge-on-insulator (GeOI) wafer operating at 2  $\mu\text{m}$  wavelengths for the first time.

**Methods:** The GeOI wafer was fabricated by following the process flow reported in [4]. Grating couplers and rib waveguides were patterned by electron-beam lithography and defined through dry etching with  $\text{CF}_4$ . After that,  $\text{SiO}_2$  hard mask was deposited for boron ion implantation to form the  $p^+$ -region of Ge PIN junction. Spin-on-glass doping with phosphorus was performed on the Ge PIN junction for high quality  $n^+$ -region formation. Nickle (Ni) and Aluminum (Al) were sputtered and succeeded by lift-off process to make electrodes. Figure 1 illustrated the schematic of the Ge lateral PIN PD and plan-view optical microscopy of a Ge PD with junction length of 500  $\mu\text{m}$ .

**Results & Conclusions:** To evaluate the generated photocurrent under illumination of lights, an amplified spontaneous emission (ASE) source at 2  $\mu\text{m}$  wavelengths was coupled into the Ge rib waveguide by grating coupler. Dark current and photocurrent were measured respectively using a 500- $\mu\text{m}$ -long Ge PD with reversed bias voltage from 0 V to -5 V as shown in Fig. 2. Noted that the coupled-in light was centered at 1960 nm. Considering the coupling loss after grating coupler and Ge waveguide propagation loss, an estimated photo responsivity of 0.25 A/W at -5V bias voltage can be obtained with quantum efficiency of approximately 16%. In conclusion, we successfully observed photodetection at 2  $\mu\text{m}$  wavelengths using Ge PIN waveguide formed on a GeOI platform that is attributable to defects-mediation mechanism, enabling a bunch of promising applications on GeOI platform at/beyond 2  $\mu\text{m}$  wavelengths.

**Acknowledgement:** This work was partly commissioned by the New Energy and Industrial Technology Development Organization (NEDO) and supported by the Canon Foundation.

**References:** [1] R. Soref, Nature Photon., 2010, 4, (8), pp. 495-497. [2] G. Fatima and B. Corbett, Opt. Photonics News, 2019, 30, pp. 42-47. [3] J. J. Ackert, D. J. Thomson, L. Shen, A. C. Peacock, P. E. Jessop, G. T. Reed, G. Z. Mashanovich and A. P. Knights, Nat. Photonics, 2015, 9, pp. 393-396. [4] J. Kang J., M. Takenaka, S. Takagi, Opt. Express, 2016, 24, (11), pp. 11855-11864.

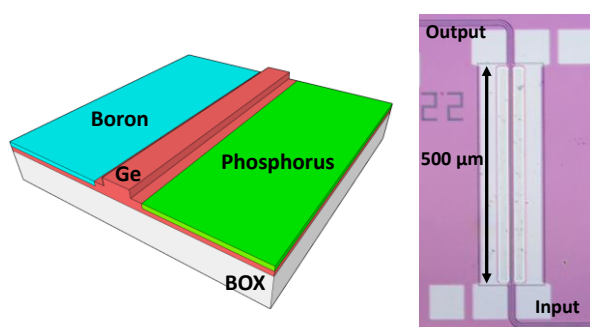


Fig. 1 Schematic of the Ge lateral PIN PD and plan-view optical microscopy of a 500- $\mu\text{m}$ -long Ge PD.

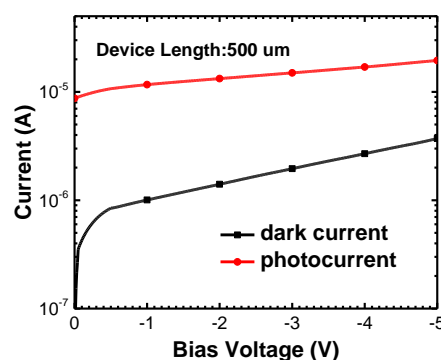


Fig. 2 I-V curve of a 500- $\mu\text{m}$ -long Ge lateral PIN PD with reversed bias voltage from 0 V to -5 V (center wavelength is at 1960 nm).